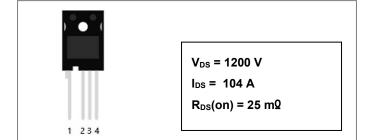


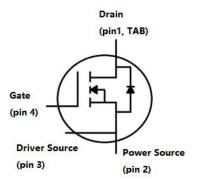
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S2M0025120K 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0025120K is single SiC Power MOSFET packaged in TO-247-4 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0025120K is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 25mQ .
- Fast switching speed and low switching losses.
- Very fast and robust intrinsic body diode.
- •"-A" is an AEC-Q101 qualified device.
- •The finish of terminals is pure matte Sn.

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	V _{GS} = 0V, I _{DS} = 100uA, T _C = 25°C	1200	V
Gate Source Voltage	V _{GSS}	T _c = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	Vgsop	T _c = 25°C Recommended Operational Values	-5 to +20	V
Continuous Drain Current	Ι _D	V _{GS} = 20V, T _C = 25°C	104	А
	ID	V _{GS} = 20V, T _C = 100°C	74	А
Pulsed Drain Current	I _{D,pulse}	Pulse width t_P limited by T_{jmax}	300	А
Power Dissipation	PD	Tc=25°C, TJ = 175 °C	535	W
Solder Temperature	TL	1.6mm (0.063") from case for 10s	260	°C

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Electrical Characteristics (T=25 $^{\circ}$ C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units	
Drain Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 100uA	1200			V	
	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 15 \text{mA}$	1.8	2.3	4	V	
Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 15mA, T _J = 175 °C		1.4		V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V			100	uA	
Gate Source Leakage Current	Igss	V _{GS} = 20V, V _{DS} = 0V			250	nA	
Drain Source On-State	_	V _{GS} = 20V, I _D = 50A		25	34	mΩ	
Resistance	$R_{\text{DS(on)}}$	V _{GS} = 20V, I _D = 50A, T _J = 175 °C		32		mΩ	
		V _{DS} = 20 V, I _{DS} = 50 A		21		S	
Transconductance	gfs	V _{DS} = 20 V, I _{DS} = 50 A, T _J = 175 °C		23		S	
Input Capacitance	CISS	V _{GS} = 0V,		4054			
Output Capacitance	Coss	V _{DS} = 1000V		246		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		17			
Coss Stored Energy	Eoss	f = 1MHz		129		uJ	
Turn-On Switching Energy	E _{ON}	V _{DS} = 800V, V _{GS} = -5/20V		1.5			
Turn-Off Switching Energy	EOFF	$I_{D} = 50A, R_{G(ext)} = 2.5\Omega$		0.3		mJ	
Turn-On Delay Time	t _{d(on)}	V _{DS} = 800V, V _{GS} = -5/20V		48			
Rise Time	tr	$I_{\rm D}$ = 50A, $R_{\rm G(ext)}$ = 2.5 Ω		18			
Turn-Off Delay Time	t _{d(off)}			55		ns	
Fall Time	t _f			19			
Internal Gate Resistance	R _{G(int)}	f = 1MHz, VAC = 25 mV		2.2		Ω	
Gate to Source Charge	Qgs	V _{DS} = 800V, V _{GS} = -5/20V		33			
Gate to Drain Charge	Q_gd	I _D = 50A		67		nC	
Total Gate Charge	Qg			165			



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Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5V, I _{SD} = 25A	3.5		V
		V _{GS} = -5V, I _{SD} = 25A, T _J = 175℃	3.1		V
Continuous Diode Forward Current	ls	V _{GS} = -5V, T _C = 25℃		130	А
Reverse Recovery Time	t _{rr}	V _{GS} =-5V, I _{SD} =50A, T _J =25°C	33		ns
Reverse Recovery Charge	Qrr	VR=800V	384		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt=1790A/µs	22		А

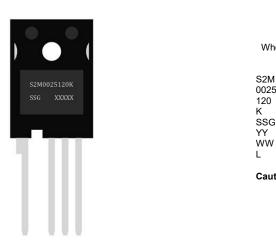
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	R _{θJC}	DC operation	0.28	°C/W
Typical Thermal Resistance Junction to Ambient	R _{0JA}		32	°C/W

Ordering Information:

Device	Package	Shipping
S2M0025120K	TO-247-4	30pcs/tube

Marking Diagram



Where XXXXX is YYWWL

S2M = Device Type

0025 = $R_{DS}(on)$

= Reverse Voltage (1200V) = Package

- SSG = SSG
 - Y = Year
 - V = Week
 - = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

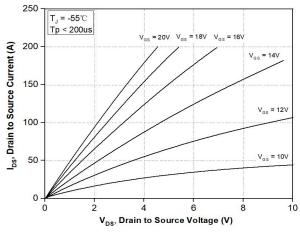
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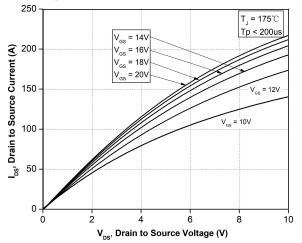
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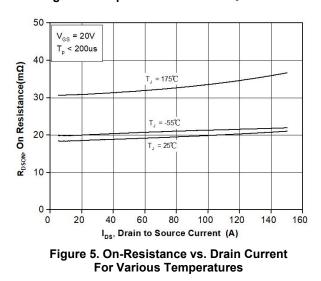
Ratings and Characteristics Curves











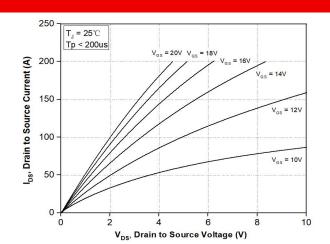


Figure 2. Output Characteristics T_J = 25 °C

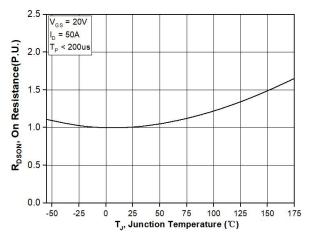
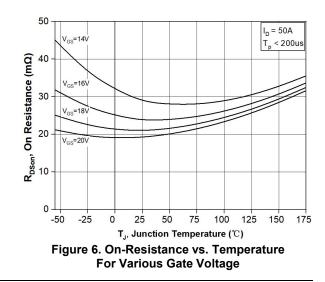


Figure 4. Normalized On-Resistance vs. Temperature



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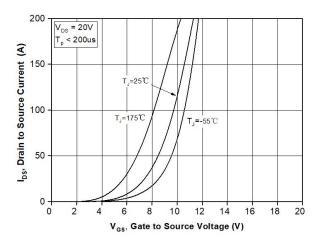


Figure 7. Transfer Characteristic for Various Junction Temperatures

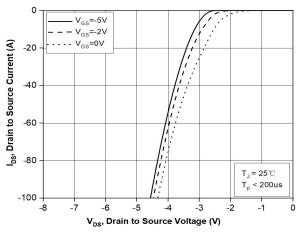


Figure 9. Body Diode Characteristic at T_J = 25 °C

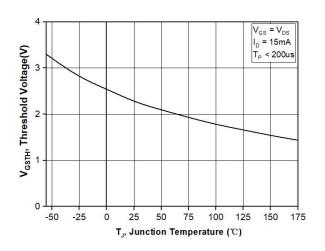


Figure 11. Threshold Voltage vs. Temperature

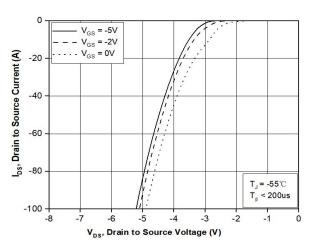


Figure 8. Body Diode Characteristic at T_J = -55 °C

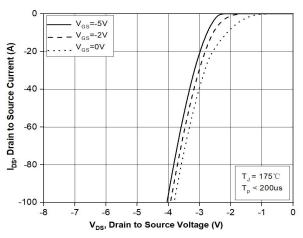


Figure 10. Body Diode Characteristic at T_J = 175 °C

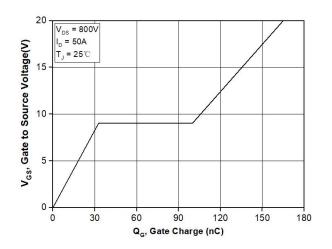


Figure 12. Gate Charge Characteristic

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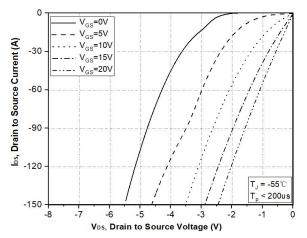


Figure 13. 3rd Quadrant Characteristic at T_J = -55 °C

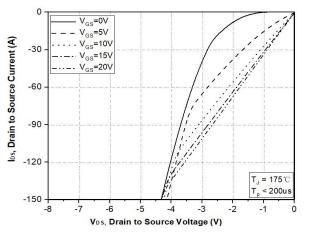
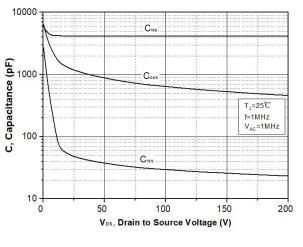
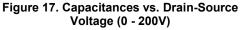


Figure 15. 3rd Quadrant Characteristic at T_J = 175°C





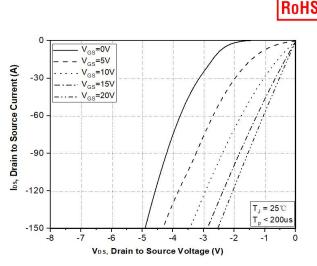


Figure 14. 3rd Quadrant Characteristic at T_J = 25 °C

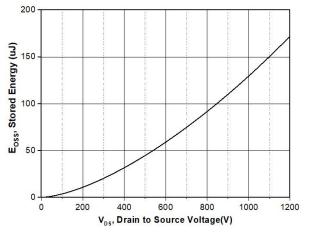


Figure 16. Output Capacitor Stored Energy

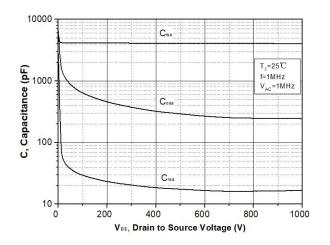


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1000V)

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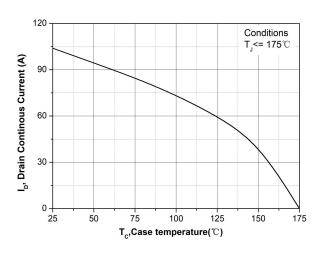


Figure 19. Continuous Drain Current Derating vs. Case Temperature

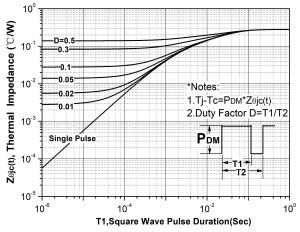
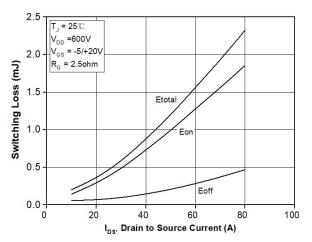


Figure 21. Transient Thermal Impedance (Junction - Case)





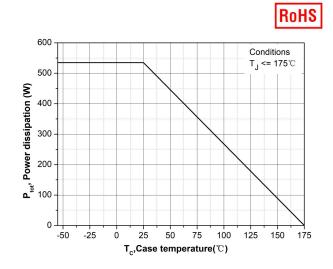


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

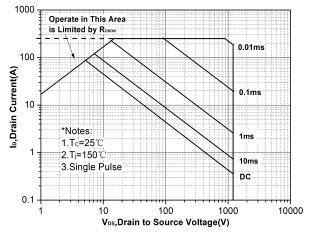


Figure 22. Safe Operating Area

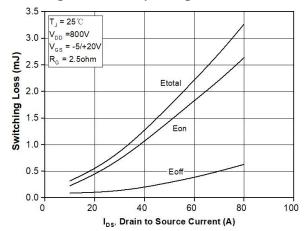


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

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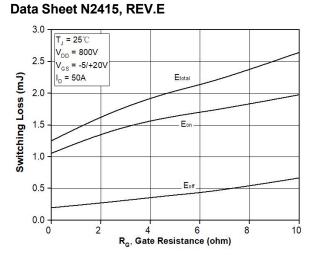


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

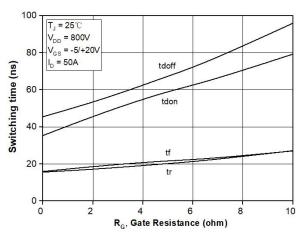


Figure 27. Switching Times vs. R_{G(ext)}

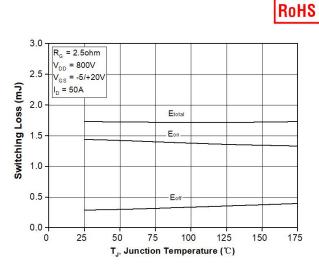


Figure 26. Clamped Inductive Switching Energy vs. Temperature

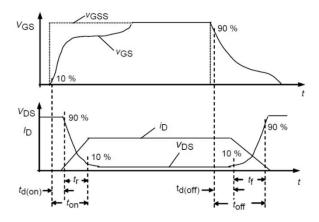


Figure 28. Switching Times Definition

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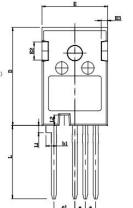


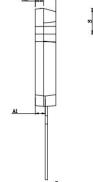
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Mechanical Dimensions TO-247-4

Our mark al	In mm			
Symbol	Min	Nom	Max	
Α	4.80	5.00	5.21	
A1	2.23	2.41	2.59	
A2	1.85	2.00	2.16	
b	1.07	1.20	1.36	
b1	2.35	2.67	2.94	
с	0.51	0.60	0.75	
D	23.30	23.45	23.60	
D1	16.25	16.55	17.65	
E	15.75	15.94	16.13	
E1	13.00	14.02	14.15	
E2	3.68	4.40	5.10	
E3	1.00	1.45	1.90	
е	2.54 BSC			
e1	5.08 BSC			
L	17.31	17.57	17.82	
L1	1.50		4.37	
ΦΡ	3.51	3.61	3.65	
ΦP1	7.19 REF			
S	6.04	6.17	6.30	







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